BLW83

DESCRIPTION

N-P-N silicon planar epitaxial transistor for use in transmitting amplifiers operating in the h.f. and v.h.f. bands, with a nominal supply voltage of 28 V. The transistor is specified for s.s.b. applications as linear amplifier in class-A and AB. The device is resistance stabilized and is guaranteed to withstand severe load mismatch conditions.

Matched h_{FE} groups are available on request.

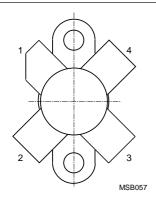
It has a 3/8" flange envelope with a ceramic cap. All leads are isolated from the flange.

QUICK REFERENCE DATA

R.F. performance

| MODE OF OPERATION | VCE V | f MHz | P∟ W | G _p dB | η _{dt} % | Ic A | d₃ dB | T _h °C | |
|-------------------|----------|----------|--------------------|----------------------|----------------------|-----------|----------|----------------------|--|
| s.s.b. (class-A) | 26 | 1,6 - 28 | 0 – 10 (P.E.P.) | > 20 | _ | 1,35 | < -40 | 70 | |
| s.s.b. (class-AB) | 28 | 1,6 - 28 | 3 – 30 (P.E.P.) | typ. 21 | typ. 40 | typ. 1,34 | typ30 | 25 | |

PIN CONFIGURATION



PINNING - SOT123

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | collector |
| 2 | emitter |
| 3 | base |
| 4 | emitter |

Fig.1 Simplified outlin

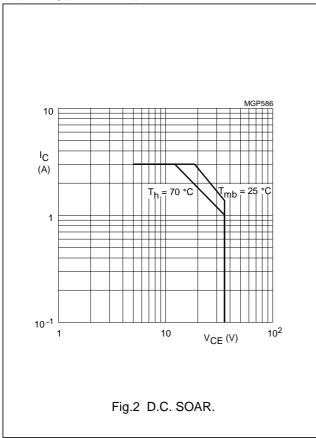
PRODUCT SAFETY This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

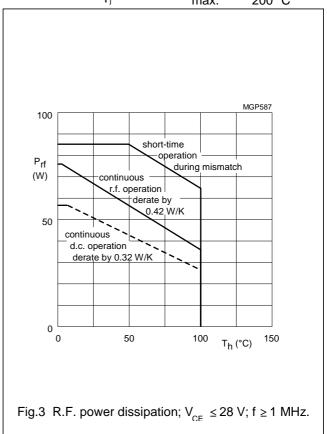
RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

From junction to mounting base (d.c. dissipation) Rth j-mb(dc) = 3,15 K/W From junction to mounting base (r.f. dissipation) Rth j-mb(rf) = 2,35 K/W From mounting base to heatsink Rth mb-h = 0,3 K/W

| Collector-emitter voltage (V _{BE} = 0) | | | |
|---|----------|--------|----------|
| peak value | Vcesm | max. | 65 V |
| Collector-emitter voltage (open base) | Vceo | max. | 36 V |
| Emitter-base voltage (open-collector) | VEBO | max. | 4 V |
| Collector current (average) | IC(AV) | max. | 3 A |
| Collector current (peak value); f > 1 MHz | Ісм | max. | 9 A |
| R.F. power dissipation (f > 1 MHz); T _{mb} = 25 °C | P_{rf} | max. | 76 W |
| Storage temperature | Tstg | -65 to | + 150 °C |
| Operating junction temperature | Tj | max. | 200 °C |





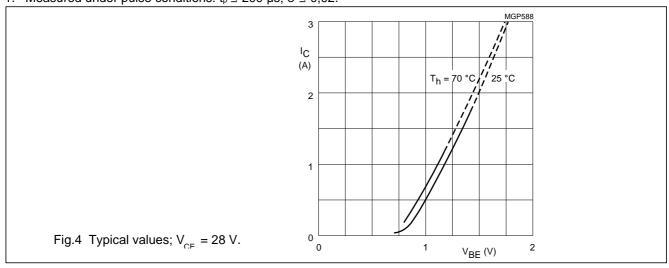
THERMAL RESISTANCE

(dissipation = 35 W; T_{mb} = 80 °C, i.e. T_h = 70 °C)

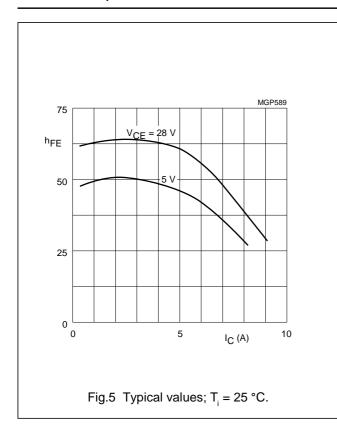
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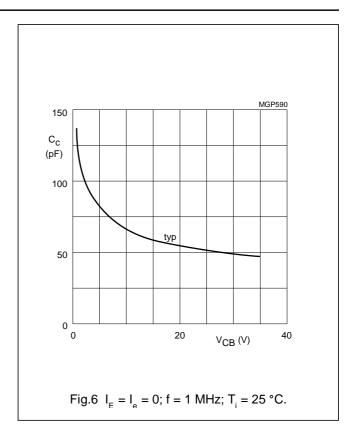
| CHARACTERISTICS | | | |
|--|------------------------|------|---------|
| $T_j = 25$ °C unless otherwise specified | | | |
| Collector-emitter breakdown voltage | | | |
| V _{BE} = 0; I _C = 10 mA | V(BR)CES | > | 65 V |
| Collector-emitter breakdown voltage open base; $I_c = 50 \text{ mA}$ | V(BR)CEO | > | 36 V |
| Emitter-base breakdown voltage | | | |
| open collector; I _E = 10 mA | $V_{(BR)EBO}$ | > | 4 V |
| Collector cut-off current | | | |
| $V_{BE} = 0$; $V_{CE} = 36 \text{ V}$ | Ices | < | 4 mA |
| Second breakdown energy; L = 25 mH; f = 50 Hz | | | |
| open base | Esbo | > | 8 mJ |
| $R_{BE} = 10 \Omega$ | Esbr | > | 8 mJ |
| D.C. current gain (1) | | typ. | 50 |
| Ic = 1,25 A; V _{CE} = 5 V | hFE | 10 | to 100 |
| D.C. current gain ratio of matched devices ⁽¹⁾ | | | |
| $I_C = 1,25 A; V_{CE} = 5 V$ | h _{FE1} /hFE2 | < | 1,2 |
| Collector-emitter saturation voltage ⁽¹⁾ | | | |
| $I_C = 3,75 \text{ A}; I_B = 0,75 \text{ A}$ | VCEsat | typ. | 1,5 V |
| Transition frequency at f = 100 MHz ⁽¹⁾ | | | |
| $-I_E = 1,25 \text{ A}; V_{CB} = 28 \text{ V}$ | fτ | typ. | 530 MHz |
| $-I_E = 3,75 \text{ A}; V_{CB} = 28 \text{ V}$ | fτ | typ. | 530 MHz |
| Collector capacitance at f = 1 MHz | | | |
| $I_E = I_e = 0$; $V_{CB} = 28 \text{ V}$ | C_c | typ. | 50 pF |
| Feedback capacitance at f = 1 MHz | | | |
| $I_C = 100 \text{ mA}; V_{CE} = 28 \text{ V}$ | Cre | typ. | 31 pF |
| Collector-flange capacitance Note | C_{cf} | typ. | 2 pF |

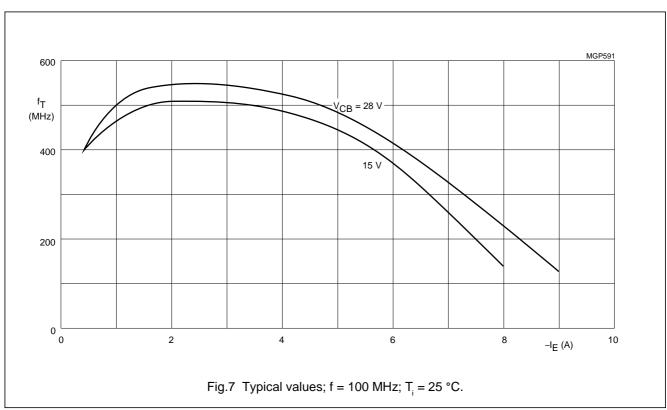
1. Measured under pulse conditions: $t_p \le 200 \ \mu s; \ \delta \le 0.02$.



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APPLICATION INFORMATION

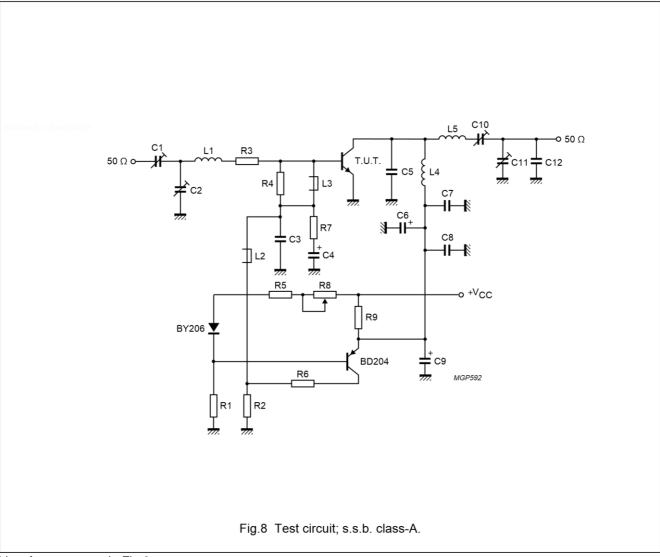
R.F. performance in s.s.b. class-A operation (linear power amplifier)

 $V_{CE} = 26 \text{ V}; f_1 = 28,000 \text{ MHz}; f_2 = 28,001 \text{ MHz}$

| OUTPUT POWER W | G _p dB | lc A | d ₃ dB (1) | d ₅ dB (1) | T _h °C |
|--------------------------------------|----------------------|---------|-------------------------------------|-------------------------------------|----------------------|
| > 10 (P.E.P.) | > 20 | 1,35 | -40 | < -40 | 70 |
| typ. 11 (P.E.P.) typ. 12 (P.E.P.) | typ. 24 | 1,35 | -40 | < -40 | 25 |

Note

1. Stated intermodulation distortion figures are referred to the according level of either of the equal amplified tones. Relative to the according peak envelope powers these figures should be increased by 6 dB.



List of components in Fig.8:

C1 = C2 = 10 to 780 pF film dielectric trimmer

C3 = 22 nF ceramic capacitor (63 V)

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C4 = $47 \mu F/10 V$ electrolytic capacitor

C5 = 56 pF ceramic capacitor (500 V)

C6 = $47 \mu F/35 V$ electrolytic capacitor

C7 = C8 = 220 nF polyester capacitor

C9 = $10 \mu F/35 V$ electrolytic capacitor

C10 = C11 = 7 to 100 pF film dielectric trimmer

C12 = 82 pF ceramic capacitor (500 V)

L1 = 3 turns closely wound enamelled Cu wire (1,6 mm); int. dia. 9,0 mm; leads to 2 × 5 mm

L2 = L3 = Ferroxcube wide-band h.f. choke, grade 3B (cat. no. 4312 020 36640)

L4 = 11 turns closely wound enamelled Cu wire (1,6 mm); int. dia. 11,0 mm

L5 = 14 turns closely wound enamelled Cu wire (1,6 mm); int. dia. 11,0 mm

R1 = 600 Ω ; parallel connection of 2 × 1,2 k Ω carbon resistors (±5%; 0,5 W each)

R2 = 15Ω carbon resistor ($\pm 5\%$; 0,25 W)

R3 = 1,2 Ω ; parallel connection of 4 × 4,7 Ω carbon resistors (±5%; 0,125 W each)

R4 = 33 Ω carbon resistor (\pm 5%; 0,25 W)

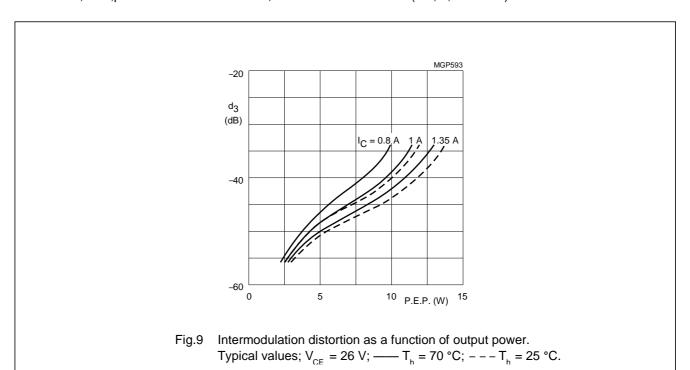
R5 = 18Ω carbon resistor ($\pm 5\%$; 0,25 W)

R6 = 120Ω wirewound resistor ($\pm 5\%$; 5,5 W)

R7 = 1Ω carbon resistor (±5%; 0,125 W)

R8 = 47Ω wirewound potentiometer (3 W)

R9 = 1,57 Ω ; parallel connection of 3 \times 4,7 Ω wirewound resistors (5%; 5,5 W each)



R.F. performance in s.s.b. class-AB operation (linear power amplifier)

 $V_{CE} = 28 \text{ V}; f_1 = 28,000 \text{ MHz}; f_2 = 28,001 \text{ MHz}$

OUTPUT POWER G_P η_{dt} (%) I_C (A) d_3 d_5 I_{C} (ZS) I_h

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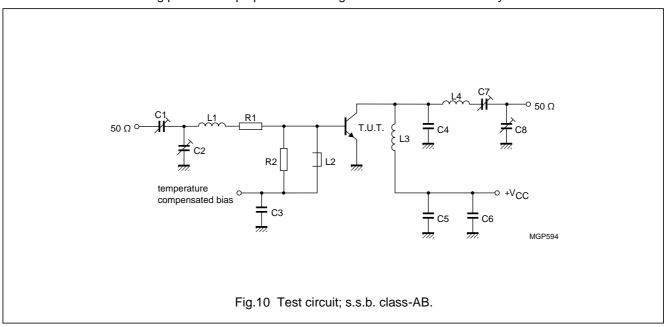
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| w | dB | at 30 W P.E.P. | | at 30 W P.E.P. | | dB (1) | dB (1) | mA | °C |
|------------------|---------|----------------|-----------|----------------|-------|---------------|---------------|----|----|
| 3 to 30 (P.E.P.) | typ. 21 | typ. 40 | typ. 1,34 | typ30 | < -30 | 25 | 25 | | |
| 3 to 25 (P.E.P.) | typ. 21 | - | - | typ30 | < -30 | 25 | 70 | | |

Note

1. Stated intermodulation distortion figures are referred to the according level of either of the equal amplified tones. Relative to the according peak envelope powers these figures should be increased by 6 dB.



List of components:

C1 = C2 = 10 to 780 pF film dielectric trimmer

C3 = C5 = C6 = 220 nF polyester capacitor

C4 = 56 pF ceramic capacitor (500 V)

C7 = C8 = 15 to 575 pF film dielectric trimmer

L1 = 4 turns closely wound enamelled Cu wire (1,6 mm); int. dia. 7,0 mm; leads 2 × 5 mm

L2 = Ferroxcube wide-band h.f. choke, grade 3B (cat. no. 4312 020 36640)

L3 = 4 turns enamelled Cu wire (1,6 mm); int. dia. 10 mm; length 9,4 mm; leads 2 × 5 mm

L4 = 7 turns enamelled Cu wire (1,6 mm); int. dia. 12 mm; length 17,2 mm; leads 2 × 5 mm

R1 = $1,2 \Omega$; parallel connection of $4 \times 4,7 \Omega$ carbon resistors

R2 = 39Ω carbon resistor

Figs 13 and 14 are typical curves and hold for an unneutralized amplifier in s.s.b. class-AB operation.

Philips Semiconductors Product specification

HF/VHF power transistor

Ruggedness in s.s.b. operation

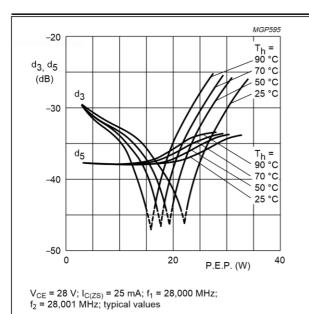


Fig.11 Intermodulation distortion as a function of output power. (1)

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 $f_1 = 28,000$ MHz; $f_2 = 28,001$ MHz; $V_{CE} = 28$ V; $T_h = 70$ °C and $P_{Lnom} = 35$ W (P.E.P.).

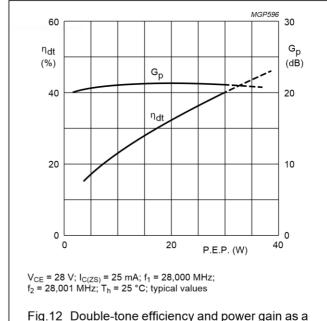
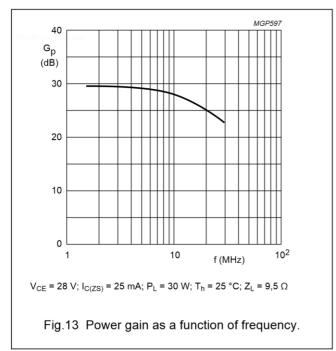
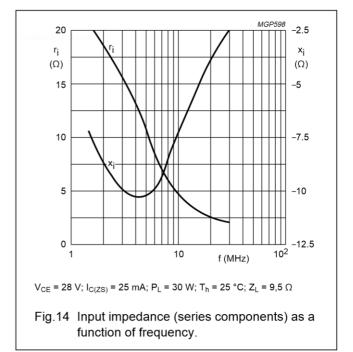


Fig.12 Double-tone efficiency and power gain as a function of output power.



The BLW83 is capable of withstanding a load mismatch (VSWR = 50) under the following conditions:

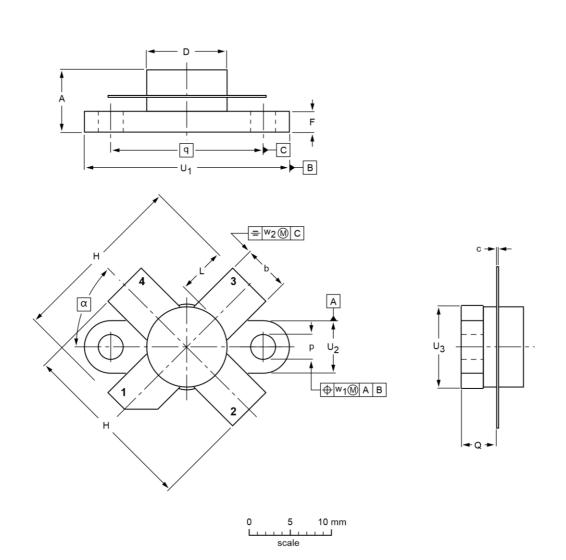
PACKAGE OUTLINE



BLW83

Flanged ceramic package; 2 mounting holes; 4 leads

SOT123A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

| UNIT | Α | b | С | D | D ₁ | F | н | L | р | Q | q | U ₁ | U ₂ | U ₃ | w ₁ | w ₂ | α |
|--------|----------------|----------------|--------------|----------------|----------------|---|----------------|---|--------------|--------------|-------|----------------|----------------|----------------|----------------|----------------|-----|
| mm | 7.47 6.37 | 5.82 5.56 | 0.18 0.10 | 9.73 9.47 | | | | | 3.33 3.04 | 4.63 4.11 | 18.42 | 25.15 24.38 | 6.61 6.09 | 9.78 9.39 | 0.51 | 1.02 | 45° |
| inches | 0.294 0.251 | 0.229 0.219 | | 0.383 0.373 | | | 0.815 0.785 | | | | | 0.99 0.96 | 0.26 0.24 | 0.385 0.370 | 0.02 | 0.04 | 40 |

| OUTLINE | | | REFER | RENCES | EUROPEAN ISSUE DATE | | | |
|---------|---|-----|-------|--------|---------------------|------------|--|--|
| VERSION | 1 | IEC | JEDEC | EIAJ | PROJECTION | ISSUE DATE | | |
| SOT123A | 4 | | | | | 97-06-28 | | |

Philips Semiconductors Product specification

HF/VHF power transistor

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DEFINITIONS

| Data Sheet Status | |
|---------------------------|---|
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| | |

Limiting values

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.